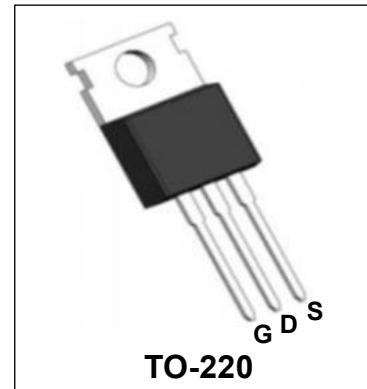


150V N-Channel MOSFETs

Description

WMK115N15HG2 uses FS's 2nd generation power trench MOSFET technology that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance. This device is well suited for high efficiency fast switching applications.

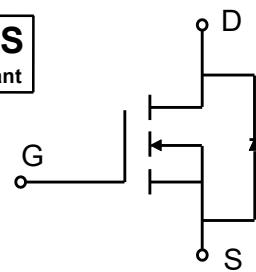


Features

- $V_{DS} = 150V$, $I_D = 90A$
- $R_{DS(on)} < 11.5m\Omega$ @ $V_{GS} = 10V$
Low $R_{DS(ON)}$
- 100% EAS Guaranteed
- High Speed Power Switching

Applications

- Hard Switching and High Speed Circuit
- DC/DC Converter
- Synchronous Rectification in SMPS



Absolute Maximum Ratings ($T_c = 25^\circ C$, unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	150	V
Gate-Source Voltage	V_{GS}	± 20	V
Continuous Drain Current $T_c=25^\circ C$	I_D	90	A
$T_c=100^\circ C$		57	
Pulsed Drain Current ⁴	I_{DM}	360	A
Single Pulse Avalanche Energy ³	EAS	245	mJ
Total Power Dissipation $T_c=25^\circ C$	P_D	173.6	W
Operating Junction and Storage Temperature Range	T_J , T_{STG}	-55 to 150	°C

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance from Junction-to-Ambient ¹	$R_{\theta JA}$	58	°C/W
Thermal Resistance from Junction-to-Case	$R_{\theta JC}$	0.72	°C/W



WMK115N15HG2

Electrical Characteristics ($T_C = 25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0V, I_D = 250\mu\text{A}$	150	-	-	V
Gate-body Leakage Current	I_{GSS}	$V_{DS} = 0V, V_{GS} = \pm 20V$	-	-	± 100	nA
Zero Gate Voltage Drain Current T _J =25°C	I_{DSS}	$V_{DS} = 150V, V_{GS} = 0V$	-	-	1	μA
T _J =100°C			-	-	100	
Gate-Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = 250\mu\text{A}$	2	3	4	V
Drain-Source On-Resistance ²	$R_{DS(\text{on})}$	$V_{GS} = 10V, I_D = 20A$	-	9.1	11.5	$\text{m}\Omega$
Forward Transconductance ²	g_{fs}	$V_{DS} = 5V, I_D = 20A$	-	66	-	S
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{DS} = 75V, V_{GS} = 0V, f = 1\text{MHz}$	-	3520	-	pF
Output Capacitance	C_{oss}		-	262	-	
Reverse Transfer Capacitance	C_{rss}		-	9.8	-	
Switching Characteristics						
Gate Resistance	R_g	$V_{DS} = 0V, V_{GS} = 0V, f = 1\text{MHz}$	-	2.4	-	Ω
Total Gate Charge	Q_g	$V_{GS} = 10V, V_{DD} = 75V, I_D = 20A$	-	45	-	nC
Gate-Source Charge	Q_{gs}		-	18	-	
Gate-Drain Charge	Q_{gd}		-	8.8	-	
Turn-On Delay Time	$t_{d(on)}$	$V_{GS} = 10V, V_{DD} = 75V, R_G = 10\Omega, I_D = 20A$	-	18	-	ns
Rise Time	t_r		-	9	-	
Turn-Off Delay Time	$t_{d(off)}$		-	32	-	
Fall Time	t_f		-	13	-	
Drain-Source Body Diode Characteristics						
Diode Forward Voltage ²	V_{SD}	$I_F = 20A, V_{GS} = 0V$	-	-	1.2	V
Continuous Source Current ^{1,5}	I_s	$V_G = V_D = 0V$, Force Current	-	-	90	A
Reverse Recovery Time	t_{rr}	$V_R = 75V, I_F = 20A, dI_F/dt = 100A/\mu\text{s}$	-	81.6	-	ns
Reverse Recovery Charge	Q_{rr}		-	162	-	nC

Notes:

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
2. The data tested by pulsed , pulse width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$
3. The EAS data shows Max. rating . The test condition is $V_{DD}=50V, V_{GS}=10V, L=0.4\text{mH}, I_{AS}=35A$
4. Repetitive rating, pulse width limited by junction temperature $T_{J(\text{MAX})}=150^\circ\text{C}$.
5. The data is theoretically the same as I_D and I_{DM} , in real applications , should be limited by total power dissipation.

Typical Characteristics

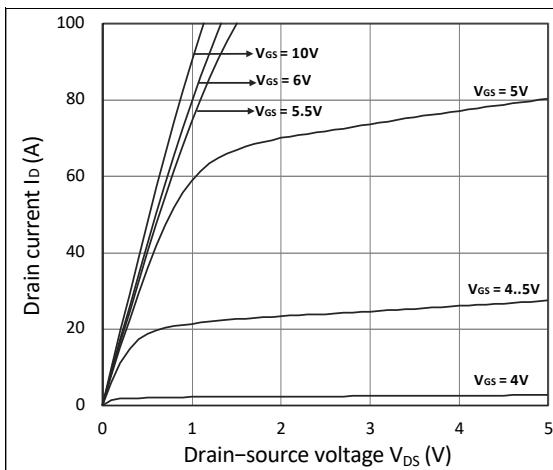


Figure 1. Output Characteristics

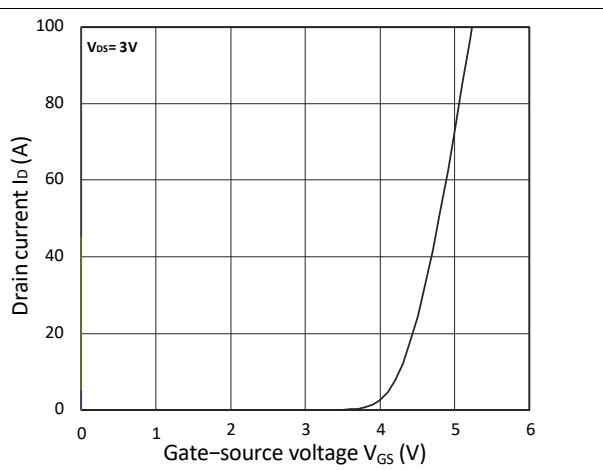


Figure 2. Transfer Characteristics

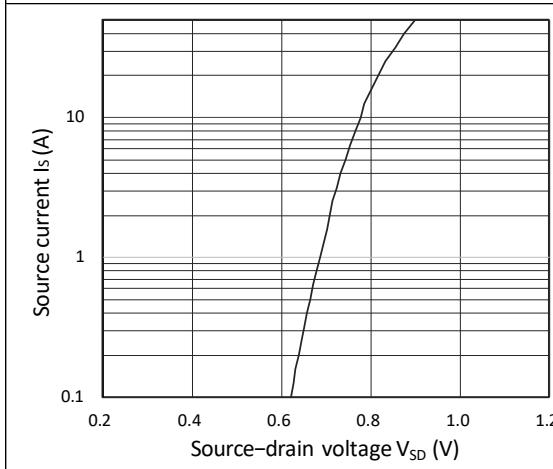
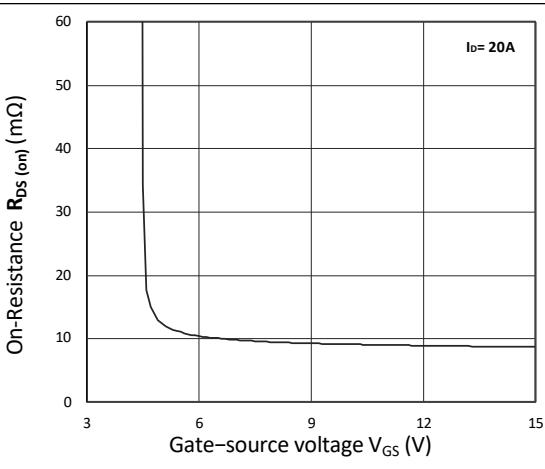
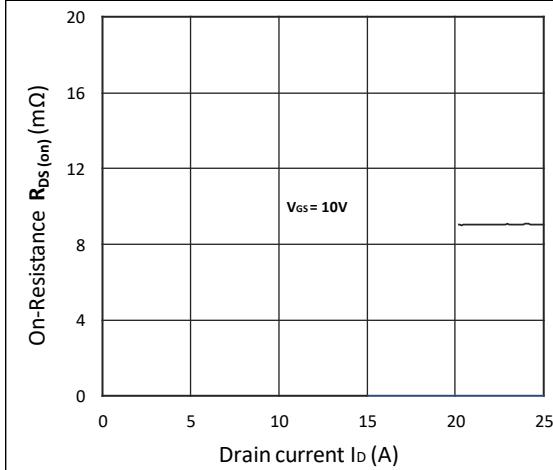
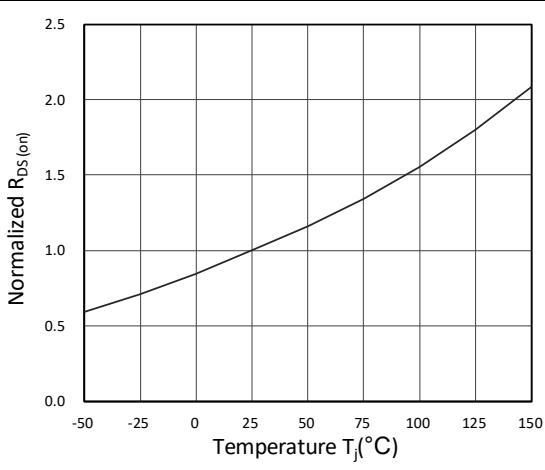
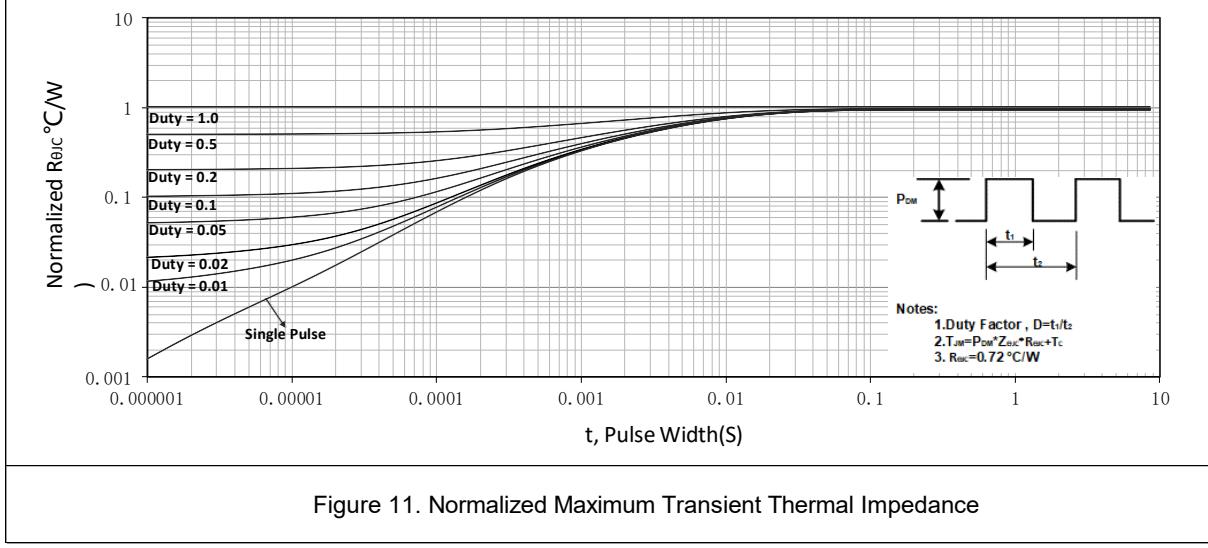
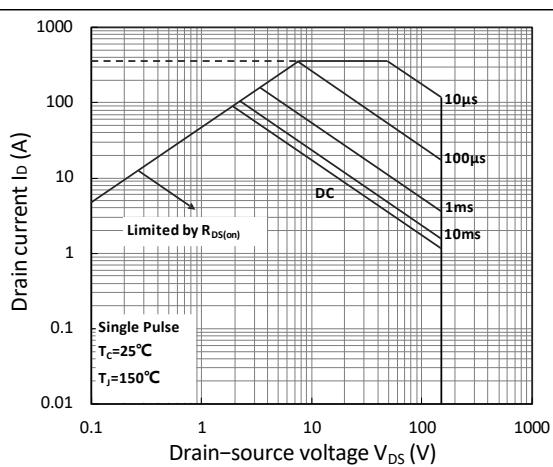
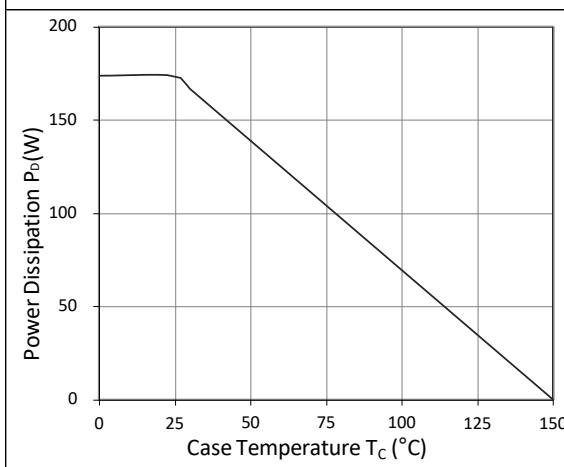
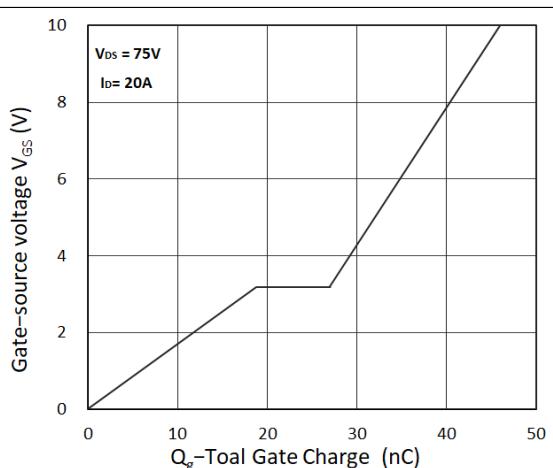
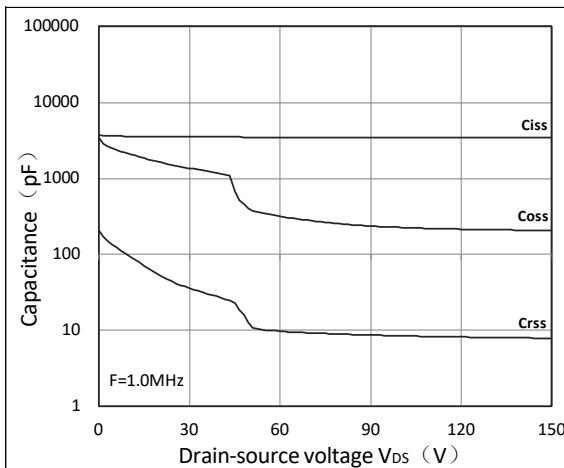
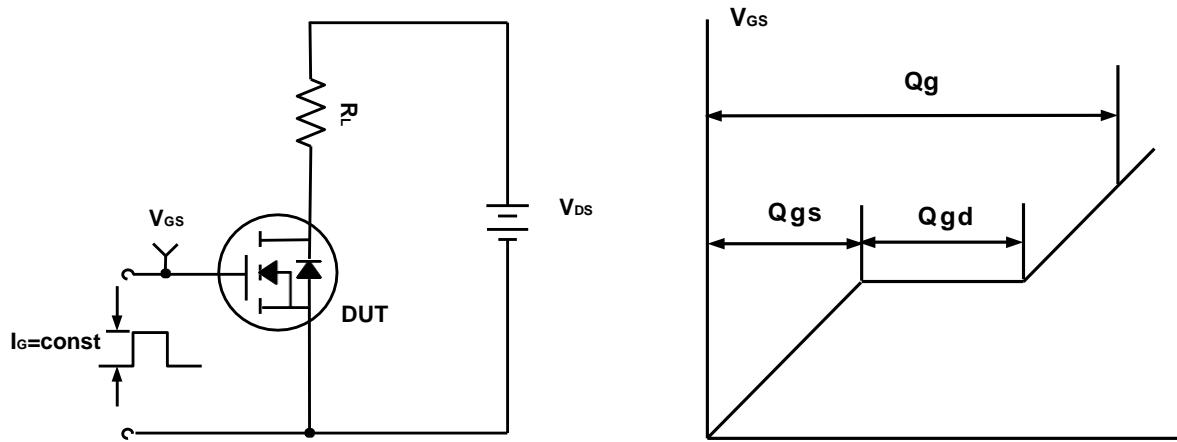
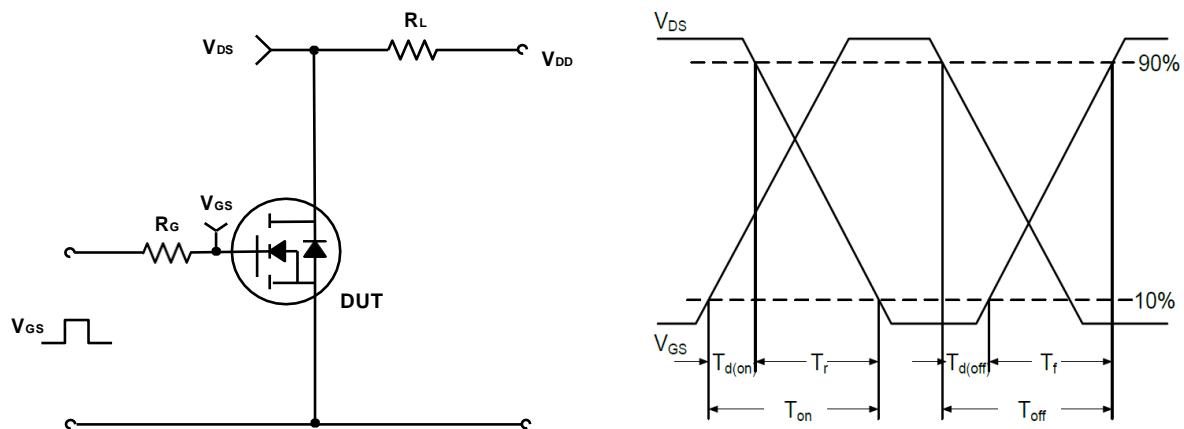
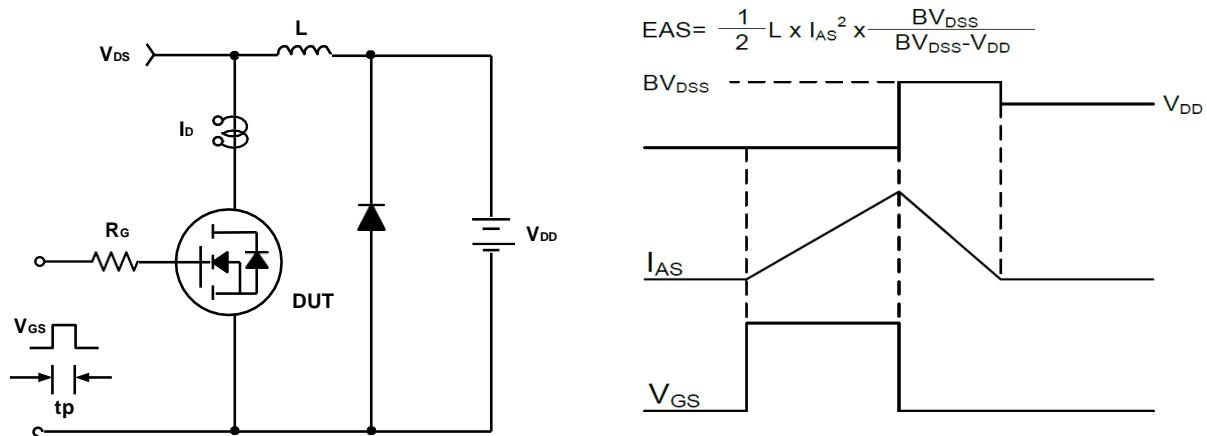


Figure 3. Forward Characteristics of Reverse

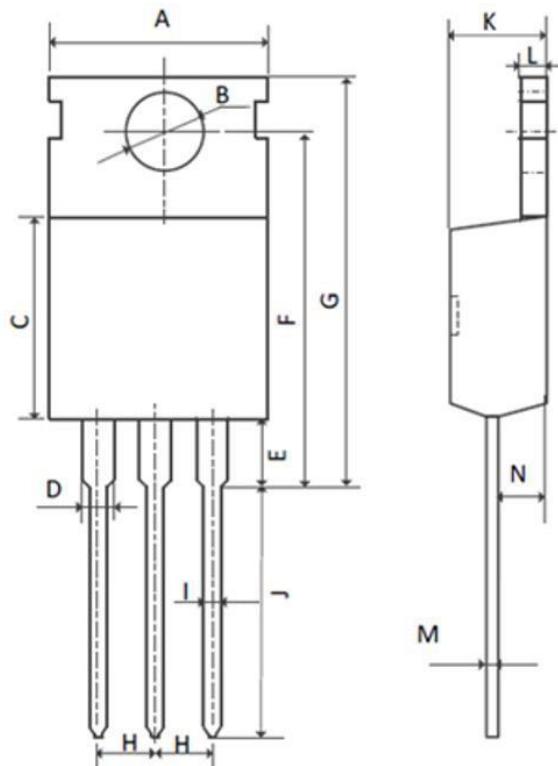
Figure 4. $R_{DS(on)}$ vs. V_{GS} Figure 5. $R_{DS(on)}$ vs. I_D Figure 6. Normalized $R_{DS(on)}$ vs. Temperature

Typical Characteristics(Con.)



Test Circuit

Figure A. Gate Charge Test Circuit & Waveforms

Figure B. Switching Test Circuit & Waveforms

Figure C. Unclamped Inductive Switching Circuit & Waveforms

Mechanical Dimensions for TO-220



SYMBOL	MM	
	MIN	MAX
A	9.70	10.30
B	3.40	3.80
C	8.80	9.40
D	1.17	1.47
E	2.60	3.50
F	15.10	16.70
G	19.55MAX	
H	2.54REF	
I	0.70	0.95
J	9.35	11.00
K	4.30	4.77
L	1.20	1.45
M	0.40	0.65
N	2.20	2.60